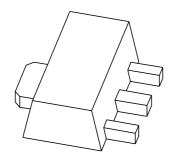
DISCRETE SEMICONDUCTORS

DATA SHEET



BC869 PNP medium power transistor; 20 V, 1 A

Product data sheet Supersedes data of 2003 Dec 02 2004 Nov 08



PNP medium power transistor; 20 V, 1 A

BC869

FEATURES

- High current
- Three current gain selections
- 1.2 W total power dissipation.

APPLICATIONS

- Linear voltage regulators
- High side switch
- Supply line switch
- MOSFET driver
- Audio (pre-) amplifier.

QUICK REFERENCE DATA

SYMBOL	PARAMETER	MIN.	MAX.	UNIT
V _{CEO}	collector-emitter voltage	_	-20	V
I _C	collector current (DC)	_	-1	Α
I _{CM}	peak collector current	_	-2	Α
h _{FE}	DC current gain			
	BC869	85	375	_
	BC869-16	100	250	_
	BC869-25	160	375	_

DESCRIPTION

PNP medium power transistor (see "Simplified outline, symbol and pinning" for package details).

PRODUCT OVERVIEW

TVDE NUMBER	PACI	ACKAGE MARKING		
TYPE NUMBER	PHILIPS	EIAJ	MARKING	
BC869	SOT89	SC-62	CEC	
BC869-16	SOT89	SC-62	CGC	
BC869-25	SOT89	SC-62	CHC	

SIMPLIFIED OUTLINE, SYMBOL AND PINNING

TYPE NUMBER	SIMPLIFIED OUTLINE AND SYMBOL	PINNING		
	SIMPLIFIED OUTLINE AND STIMBOL	PIN	DESCRIPTION	
BC869		1	emitter	
	2	2	collector	
	3 2 1 1 sym079	3	base	

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ORDERING INFORMATION

TVDE NUMBED		PACKAGE		
TYPE NUMBER NAME		DESCRIPTION	VERSION	
BC869	SC-62	plastic surface mounted package; collector pad for good heat	SOT89	
BC869-16		transfer; 3 leads		
BC869-25				

LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

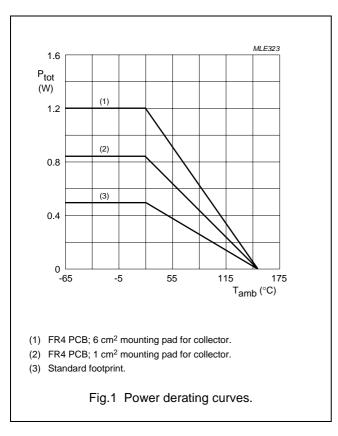
SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V_{CBO}	collector-base voltage	open emitter	_	-32	V
V _{CEO}	collector-emitter voltage	open base	_	-20	V
V _{EBO}	emitter-base voltage	open collector	_	-5	V
Ic	collector current (DC)		_	-1	А
I _{CM}	peak collector current		_	-2	А
I _{BM}	peak base current		_	-200	mA
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C			
		notes 1 and 2	_	0.5	W
		notes 1 and 3	_	0.85	W
		notes 1 and 4	_	1.2	W
T _{stg}	storage temperature		-65	+150	°C
Tj	junction temperature		-	150	°C
T _{amb}	ambient temperature		-65	+150	°C

Notes

- 1. Refer to SOT89 standard mounting conditions.
- 2. Device mounted on an FR4 printed-circuit board, single-sided copper, tin-plated footprint.
- 3. Device mounted on an FR4 printed-circuit board, single-sided copper, tin-plated, mounting pad for collector 1 cm².
- 4. Device mounted on an FR4 printed-circuit board, single-sided copper, tin-plated, mounting pad for collector 6 cm².

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THERMAL CHARACTERISTICS

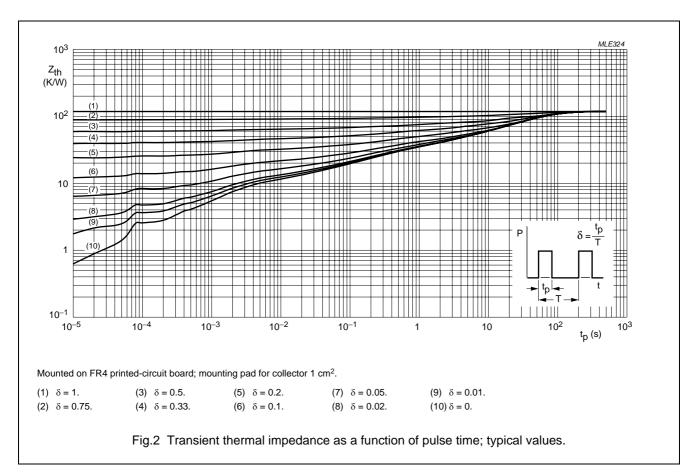
SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R _{th(j-a)}	thermal resistance from junction to ambient	$T_{amb} \le 25 ^{\circ}C$		
		notes 1 and 2	250	K/W
		notes 1 and 3	147	K/W
		notes 1 and 4	104	K/W
R _{th(j-s)}	thermal resistance from junction to solder point	T _{amb} ≤ 25 °C	20	K/W

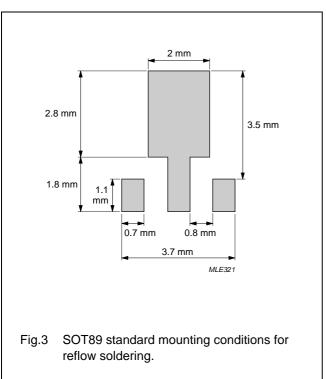
Notes

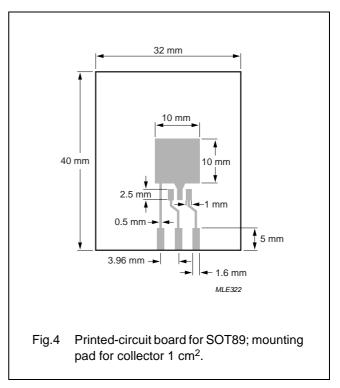
- 1. Refer to SOT89 standard mounting conditions.
- 2. Device mounted on an FR4 printed-circuit board, single-sided copper, tin-plated footprint.
- 3. Device mounted on an FR4 printed-circuit board, single-sided copper, tin-plated, mounting pad for collector 1 cm².
- 4. Device mounted on an FR4 printed-circuit board, single-sided copper, tin-plated, mounting pad for collector 6 cm².

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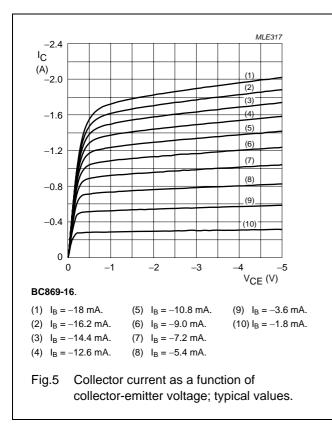
CHARACTERISTICS

 T_{amb} = 25 °C unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
I _{CBO}	collector-base cut-off current	$V_{CB} = -25 \text{ V}; I_E = 0 \text{ A}$	_	_	-100	nA
		$V_{CB} = -25 \text{ V}; I_E = 0 \text{ A}$	_	_	-10	μΑ
I _{EBO}	emitter-base cut-off current	$V_{EB} = -5 \text{ V}; I_C = 0 \text{ A}$	-	_	-100	nA
h _{FE}	DC current gain	BC869				
		$V_{CE} = -10 \text{ V}; I_{C} = -5 \text{ mA}$	50	_	_	
		$V_{CE} = -1 \text{ V}; I_{C} = -500 \text{ mA}$	85	_	375	
		$V_{CE} = -1 \text{ V}; I_{C} = -1 \text{ A}$	60	_	_	
		BC869-16				
		$V_{CE} = -1 \text{ V}; I_{C} = -500 \text{ mA}$	100	_	250	
		BC869-25				
		$V_{CE} = -1 \text{ V}; I_{C} = -500 \text{ mA}$	160	_	375	
V_{CEsat}	collector-emitter saturation voltage	$I_C = -1 \text{ A}; I_B = -100 \text{ mA}$	_	_	-500	mV
V_{BE}	base-emitter voltage	$V_{CE} = -10 \text{ V}; I_{C} = -5 \text{ mA}$	-	_	-700	mV
		$V_{CE} = -1 \ V; \ I_{C} = -1 \ A$	_	_	-1	V
C _c	collector capacitance	$I_E = I_e = 0 \text{ A}; V_{CB} = -10 \text{ V};$ f = 1 MHz	_	28	_	pF
f _T	transition frequency	$V_{CE} = -5 \text{ V}; I_{C} = -50 \text{ mA};$ f = 100 MHz	40	140	_	MHz

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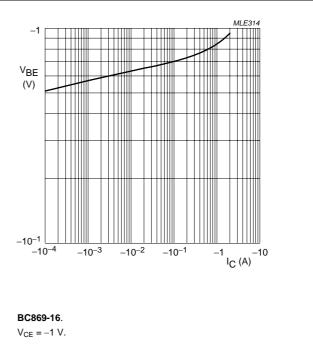
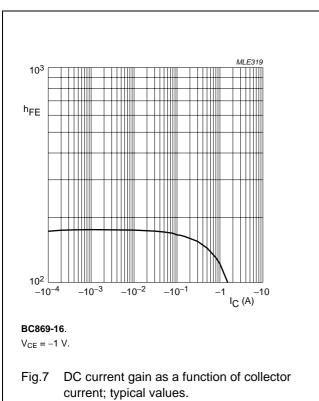
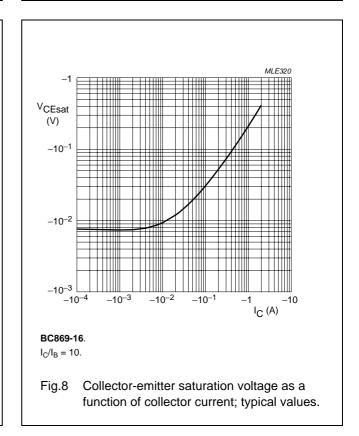


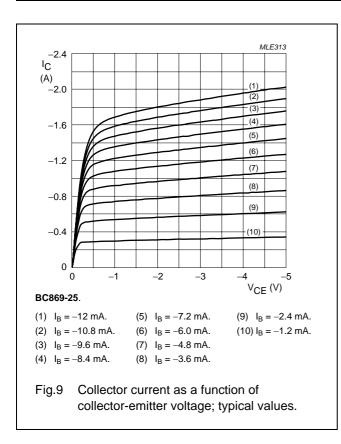
Fig.6 Base-emitter voltage as a function of collector current; typical values.





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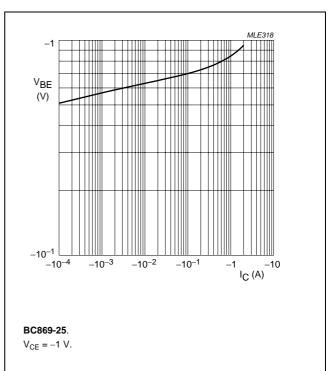


Fig.10 Base-emitter voltage as function of collector current; typical values.

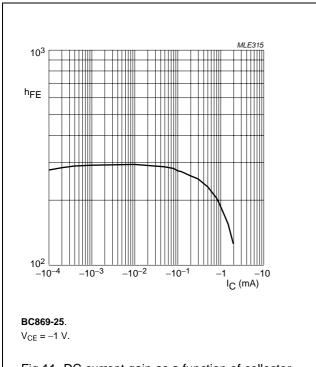
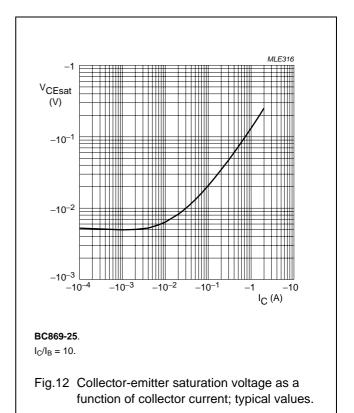


Fig.11 DC current gain as a function of collector current; typical values.



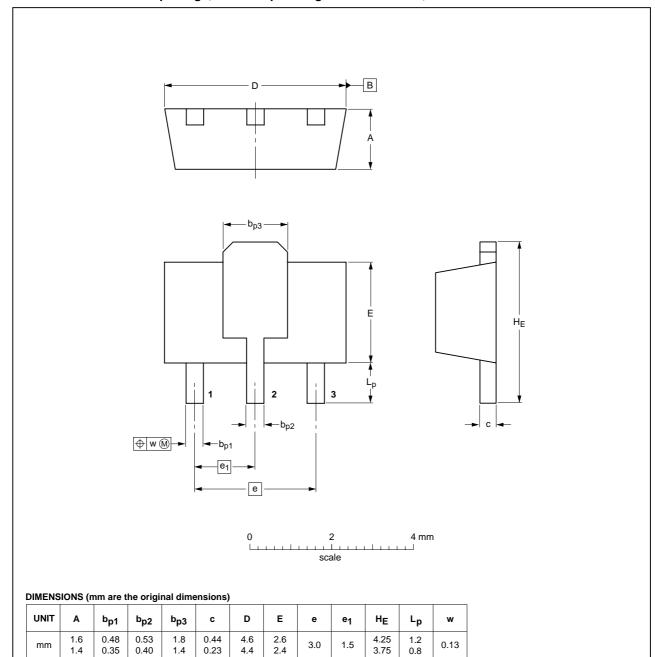
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PACKAGE OUTLINE

Plastic surface-mounted package; collector pad for good heat transfer; 3 leads

SOT89



OUTLINE	REFERENCES			EUROPEAN	ISSUE DATE	
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
SOT89		TO-243	SC-62			04-08-03 06-03-16

PNP medium power transistor; 20 V, 1 A

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DATA SHEET STATUS

DOCUMENT STATUS ⁽¹⁾	PRODUCT STATUS ⁽²⁾	DEFINITION
Objective data sheet	Development	This document contains data from the objective specification for product development.
Preliminary data sheet	Qualification	This document contains data from the preliminary specification.
Product data sheet	Production	This document contains the product specification.

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Contact information

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